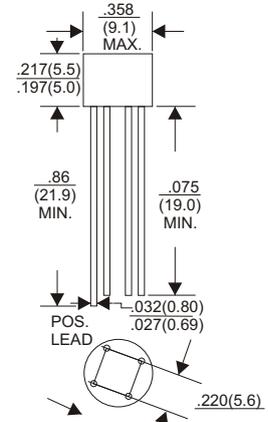


FEATURES

- Rating to 1000V PRVP
- Surge overload rating to 40 Amperes peak
- Glass passivated chip junctions
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- Lead solderable per MIL-STD-202 method 208
- Lead: silver plated copper, solderde plated
- Plastic material has UL flammability classification 94V-0



WOM



Maximum Ratings (@TA = 25°C unless otherwise specified)

Characteristic	Symbol	2W005A	2W010A	2W020A	2W040A	2W060A	2W080A	2W100A	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Reverse Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward Output current @TA=40°C	$I_{F(AV)}$	2.0							A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load	I_{FSM}	60							A
Current squared time $t < 8.3ms$, Ta = 25°C	I^2t	15							A ² s

Thermal Characteristics

Characteristic	Symbol	2W005M	2W010M	2W020M	2W040M	2W060M	2W080M	2W100M	UNITS
Typical thermal resistance junction to lead	$R_{\theta JA}$	40							C/W
On aluminum substrate	$R_{\theta JL}$	15							
Operating junction temperature range	T_J	-55 -150							°C
Storage temperature range	T_{STG}	-55 -150							°C

Electrical Characteristics (@TA = 25°C unless otherwise specified)

Characteristic	Symbol	2W005M	2W010M	2W020M	2W040M	2W060M	2W080M	2W100M	UNITS
Maximum instantaneous forward voltage at 2.0A	V_F	1.1							V
Maximum reverse current @TA=25°C	I_R	10							μA
at rated DC blocking voltage @TA=100°C		1.0							mA

Fig. 1 - Forward Current Derating Curve

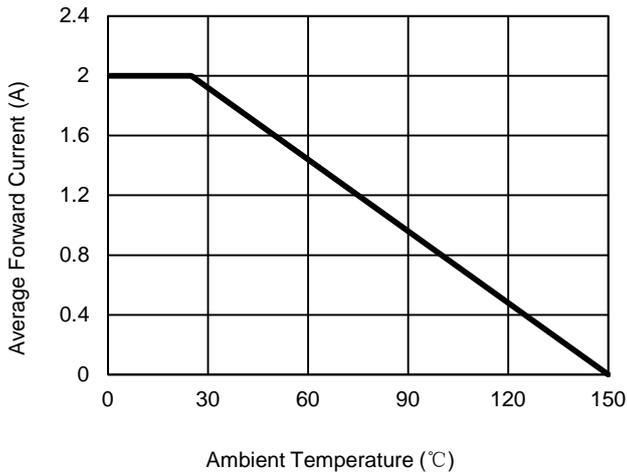


Fig. 2 - Maximum Non-Repetitive Surge Current

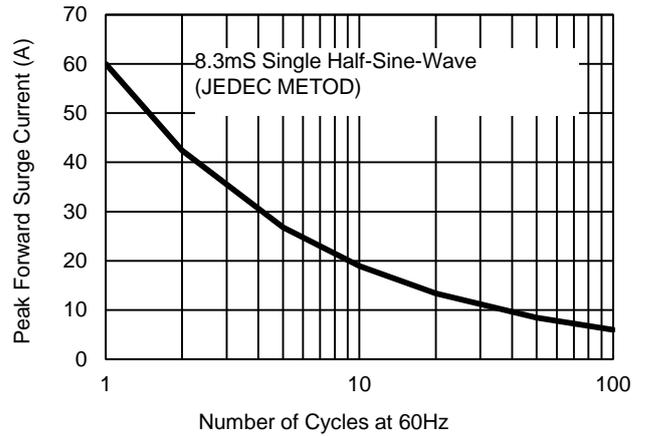


Fig. 3 - Typical Reverse Characteristics

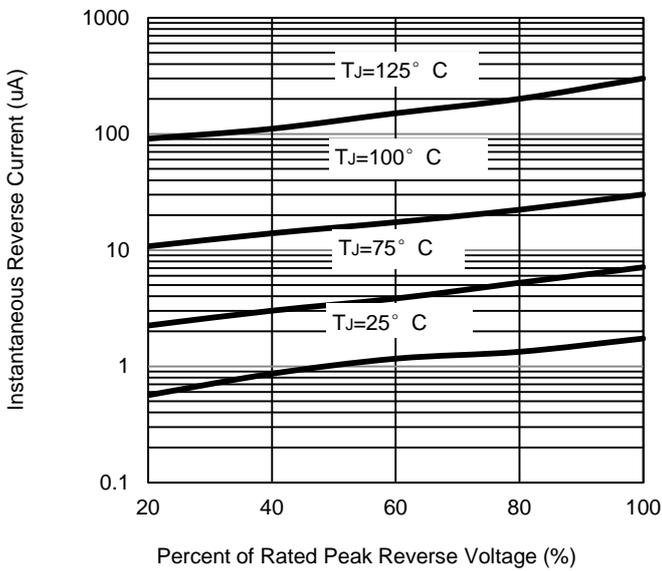


Fig. 4 - Typical Forward Characteristics

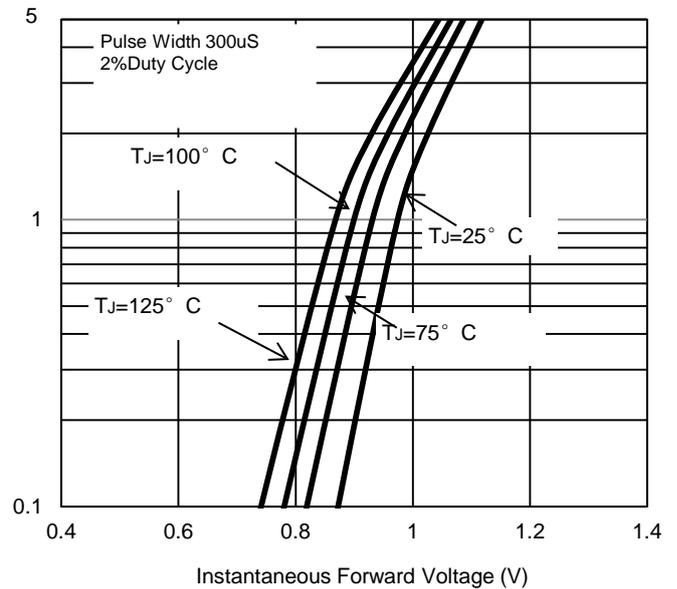
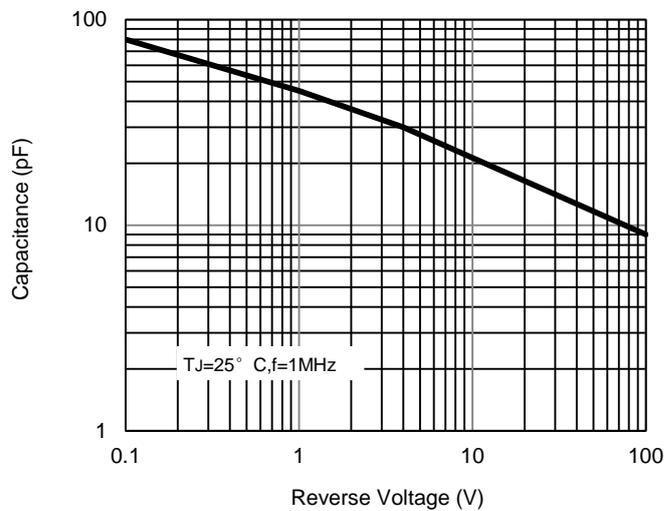


Fig. 5 - Typical Junction Capacitance



Device	Shipping
2W005M-2W10M	50unit/pipe